



Table of Contents

1 Overview	2
2 Functional Safety Failure In Time (FIT) Rates	3
3 Failure Mode Distribution (FMD)	4
4 Pin Failure Mode Analysis (Pin FMA)	5

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1 Overview

This document contains information for the LM25143-Q1 (VQFN package) to aid in a functional safety system design. Information provided are:

- Functional Safety Failure In Time (FIT) rates of the semiconductor component estimated by the application of industry reliability standards
- Component failure modes and their distribution (FMD) based on the primary function of the device
- Pin failure mode analysis (Pin FMA)

Figure 1-1 shows the device functional block diagram for reference.

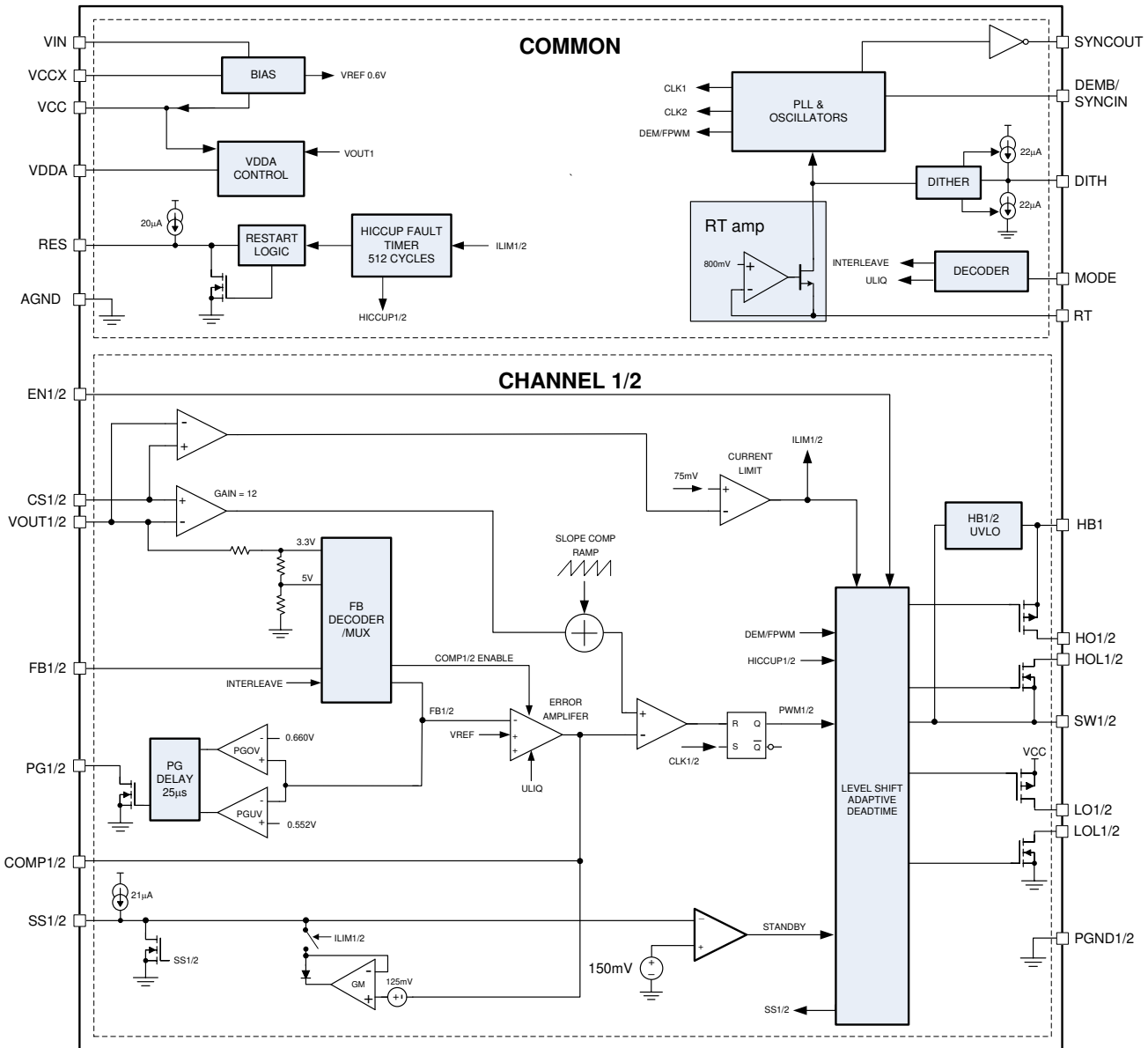


Figure 1-1. Functional Block Diagram

The LM25143-Q1 was developed using a quality-managed development process, but was not developed in accordance with the IEC 61508 or ISO 26262 standards.

2 Functional Safety Failure In Time (FIT) Rates

This section provides Functional Safety Failure In Time (FIT) rates for the LM25143-Q1 based on two different industry-wide used reliability standards:

- [Table 2-1](#) provides FIT rates based on IEC TR 62380 / ISO 26262 part 11
- [Table 2-2](#) provides FIT rates based on the Siemens Norm SN 29500-2

Table 2-1. Component Failure Rates per IEC TR 62380 / ISO 26262 Part 11

FIT IEC TR 62380 / ISO 26262	FIT (Failures Per 10 ⁹ Hours)
Total Component FIT Rate	32
Die FIT Rate	7
Package FIT Rate	25

The failure rate and mission profile information in [Table 2-1](#) comes from the Reliability data handbook IEC TR 62380 / ISO 26262 part 11:

- Mission Profile: Motor Control from Table 11
- Power dissipation: 750 mW
- Climate type: World-wide Table 8
- Package factor (lambda 3): Table 17b
- Substrate Material: FR4
- EOS FIT rate assumed: 0 FIT

Table 2-2. Component Failure Rates per Siemens Norm SN 29500-2

Table	Category	Reference FIT Rate	Reference Virtual T _J
5	CMOS, BICMOS ASICs Analog & Mixed HV > 50-V supply	32 FIT	55°C

The Reference FIT Rate and Reference Virtual T_J (junction temperature) in [Table 2-2](#) come from the Siemens Norm SN 29500-2 tables 1 through 5. Failure rates under operating conditions are calculated from the reference failure rate and virtual junction temperature using conversion information in SN 29500-2 section 4.

3 Failure Mode Distribution (FMD)

The failure mode distribution estimation for the LM25143-Q1 in [Table 3-1](#) comes from the combination of common failure modes listed in standards such as IEC 61508 and ISO 26262, the ratio of sub-circuit function size and complexity and from best engineering judgment.

The failure modes listed in this section reflect random failure events and do not include failures due to misuse or overstress.

Table 3-1. Die Failure Modes and Distribution

Die Failure Modes	Failure Mode Distribution (%)
SW1/2 no output	45
SW1/2 output not in specification – voltage or timing	40
SW1/2 power FET stuck on	5
PG1/2 false trip or fails to trip	5
Short circuit any two pins	5

The FMD in [Table 3-1](#) excludes short circuit faults across the isolation barrier. Faults for short circuit across the isolation barrier can be excluded according to ISO 61800-5-2:2016 if the following requirements are fulfilled:

1. The signal isolation component is OVC III according to IEC 61800-5-1. If a SELV/PELV power supply is used, pollution degree 2/OVC II applies. All requirements of IEC 61800-5-1:2007, 4.3.6 apply.
2. Measures are taken to ensure that an internal failure of the signal isolation component cannot result in excessive temperature of its insulating material.

Creepage and clearance requirements should be applied according to the specific equipment isolation standards of an application. Care should be taken to maintain the creepage and clearance distance of a board design to ensure that the mounting pads of the isolator on the printed-circuit board do not reduce this distance.

4 Pin Failure Mode Analysis (Pin FMA)

This section provides a Failure Mode Analysis (FMA) for the pins of the LM25143-Q1. The failure modes covered in this document include the typical pin-by-pin failure scenarios:

- Pin short-circuited to Ground (see [Table 4-2](#))
- Pin open-circuited (see [Table 4-3](#))
- Pin short-circuited to an adjacent pin (see [Table 4-4](#))
- Pin short-circuited to VIN (see [Table 4-5](#))

[Table 4-2](#) through [Table 4-5](#) also indicate how these pin conditions can affect the device as per the failure effects classification in [Table 4-1](#).

Table 4-1. TI Classification of Failure Effects

Class	Failure Effects
A	Potential device damage that affects functionality
B	No device damage, but loss of functionality
C	No device damage, but performance degradation
D	No device damage, no impact to functionality or performance

[Figure 4-1](#) shows the LM25143-Q1 pin diagram. For a detailed description of the device pins please refer to the *Pin Configuration and Functions* section in the LM25143-Q1 data sheet.

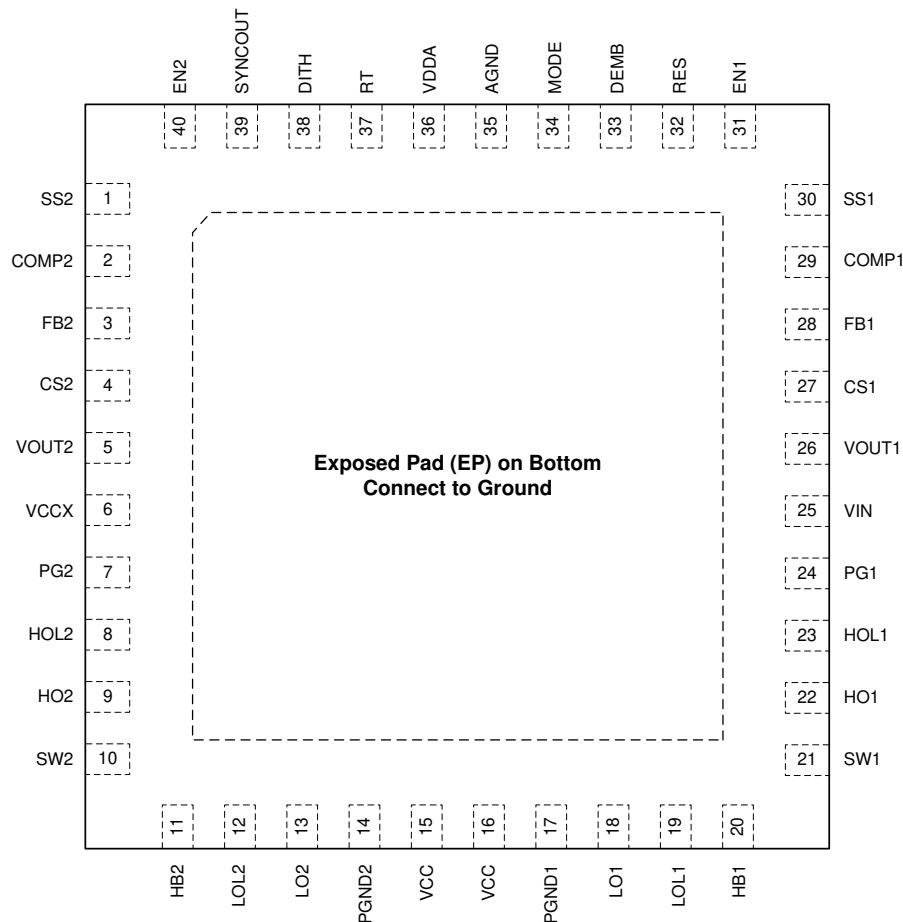


Figure 4-1. Pin Diagram

Following are the assumptions of use and the device configuration assumed for the pin FMA in this section:

- Application Circuit from the LM25143-Q1 data sheet is used.
- PG1 and PG2 are pulled up to VOUT1 and VOUT2.

Table 4-2. Pin FMA for Device Pins Short-Circuited to Ground

Pin Name	Pin No.	Description of Potential Failure Effect(s)	Failure Effect Class
SS2	1	VOUT1 = regulation, VOUT2 = 0 V	B
COMP2	2	VOUT1 = regulation, VOUT2 = 0 V	B
FB2	3	If FB = VDDA, VOUT1 and VOUT2 = 0 V.	B
		If FB = GND, VOUT1 = regulation and VOUT2 = 5 V.	B
CS2	4	VOUT1 = regulation, VOUT2 = oscillation	C
VOUT2	5	VOUT1 = regulation, VOUT2 = 0 V, excessive current from VIN, and enters overcurrent protection	B
VCCX	6	If VCCX = GND, VOUT1 and VOUT2 = regulation.	D
		If VCCX is connected to VOUT2, VOUT1 = regulation, VOUT2 = 0 V, and the internal VCC regulator is used.	B
		If VCCX is connected to an external supply, VOUT1 and VOUT2 = regulation.	B
PG2	7	VOUT1 and VOUT2 = regulation, PG2 is forced low.	B
HOL2	8	VOUT1 and VOUT2 = 0 V, VCC is pulled low through HB2.	B
HO2	9	VOUT1 and VOUT2 = 0 V, VCC is pulled low through HB2.	B
SW2	10	VOUT1 = regulation, VOUT2 = 0 V, and excessive current from VIN	A
HB2	11	VOUT1 and VOUT2 = 0 V, VCC regulator loaded to current limit	B
LOL2	12	VOUT1 and VOUT2 = regulation	D
LO2	13	VOUT1 and VOUT2 = regulation	C
PGND2	14	VOUT1 and VOUT2 = regulation	D
VCC	15	VOUT1 and VOUT2 = 0 V	B
VCC	16	VOUT1 and VOUT2 = 0 V	B
PGND1	17	VOUT1 and VOUT2 = regulation	D
LO1	18	VOUT1 and VOUT2 = regulation	C
LOL1	19	VOUT1 and VOUT2 = regulation	C
HB1	20	VOUT1 and VOUT2 = 0 V, VCC regulator load to current limit	B
SW1	21	VOUT1 = regulation, VOUT2 = 0 V, and excessive current from VIN	B
HO1	22	VOUT1 and VOUT2 = 0 V	B
HOL1	23	VOUT1 and VOUT2 = 0 V	B
PG1	24	VOUT1 and VOUT2 = regulation, PG1 forced low	C
VIN	25	VOUT1 and VOUT2 = 0 V	A
VOUT1	26	VOUT1 = 0 V, VOUT2 = regulation, and excessive current from VIN	B
CS1	27	VOUT1 = oscillation, VOUT2 = regulation	C
FB1	28	If FB1 = VDDA, VOUT1 and VOUT2 = 0 V.	B
		If FB1 = GND, VOUT1 = 5 V expected and VOUT2 = regulation.	B
COMP1	29	VOUT1 = 0 V, VOUT2 = regulation	B
SS1	30	VOUT1 = 0 V, VOUT2 = regulation	B
EN1	31	VOUT1 = 0 V, VOUT2 = regulation	B
RES	32	VOUT1 and VOUT2 = regulation, cannot exit hiccup mode	B
DEMB	33	If DEMB = VDDA, VOUT1 and VOUT2 = 0 V.	B
		VOUT1 and VOUT2 = regulation	C
MODE	34	If MODE = VDDA, VOUT1 and VOUT2 = 0 V.	B
		If MODE = GND, VOUT1 and VOUT2 = regulation.	D
AGND	35	VOUT1 and VOUT2 = regulation	D
VDDA	36	VOUT1 and VOUT2 = 0 V, no switching	B
RT	37	VOUT1 and VOUT2 = regulation, operating at the maximum switching frequency	C
DITH	38	VOUT1 and VOUT2 = regulation	C
SYNCOUT	39	VOUT1 and VOUT2 = regulation	D
EN2	40	VOUT1 = 0 V, VOUT2 = regulation	B

Table 4-3. Pin FMA for Device Pins Open-Circuited

Pin Name	Pin No.	Description of Potential Failure Effect(s)	Failure Effect Class
SS2	1	VOUT1 and VOUT2 = regulation	D
COMP2	2	VOUT1 = regulation, VOUT2 = oscillation and does not regulate	C
FB2	3	VOUT2 = regulation and VOUT2 = does not regulate. The controller is configured for adjustable output.	B
CS2	4	VOUT1 = regulation, VOUT2 oscillation, and no overcurrent detection	A
VOUT2	5	VOUT1 = regulation, VOUT2 = oscillation, and does not regulate	A
VCCX	6	VOUT1 and VOUT2 = regulation	D
PG2	7	VOUT1 and VOUT2 = regulation, no PG2 information	C
HOL2	8	VOUT1 = regulation, VOUT2 = VIN, does not regulate, and excessive current from VIN	D
HO2	9	VOUT1 = regulation, VOUT2 = 0 V, and does not regulate	B
SW2	10	VOUT1 = regulation, VOUT2 = VIN, and high-side FET control floating	A
HB2	11	VOUT1 = regulation, VOUT2 = 0 V, high-side gate drive floating	B
LOL2	12	VOUT1 = regulation, VOUT2 = 0 V, and no gate discharge path for the low-side MOSFET	B
LO2	13	VOUT1 and VOUT2 = regulation, lower efficiency	C
PGND2	14	VOUT1 and VOUT2 = 0 V, uncontrolled behavior because of the floating ground	B
VCC	15	VOUT1 and VOUT2 = 0 V	B
VCC	16	VOUT1 and VOUT2 = 0 V	B
PGND1	17	VOUT1 and VOUT2 = 0 V, uncontrolled behavior because of the floating ground	B
LO1	18	VOUT1 = regulation, lower efficiency, and VOUT2 = regulation	C
LOL1	19	VOUT1 = 0 V, no discharge path for low-side MOSFET, and VOUT2 = regulation	B
HB1	20	VOUT1 = regulation, VOUT2 = 0 V, and high-side gate drive floating	B
SW1	21	VOUT1 = no regulation, high-side FET control floating, and VOUT2 = regulation	A
HO1	22	VOUT1 = does not regulate, VOUT2 = regulation	B
HOL1	23	VOUT1 = VIN, does not regulate, excessive current from VIN, and VOUT2 = regulation	C
PG1	24	VOUT1 and VOUT2 = regulation, no PG1 information	C
VIN	25	VOUT1 and VOUT2 = 0 V	B
VOUT1	26	VOUT1 = oscillation, does not regulate, and VOUT2 = regulation	A
CS1	27	VOUT1 = oscillation, no overcurrent detection, and VOUT2 = regulation	A
FB1	28	VOUT2 = does not regulate. The controller is configured for adjustable output. VOUT2 = regulation	B
COMP1	29	VOUT1 = oscillation and does not regulate, VOUT2 = regulation	B
SS1	30	VOUT1 and VOUT2 = regulation	D
EN1	31	VOUT1 and VOUT2 = 0 V	B
RES	32	VOUT1 and VOUT2 = regulation and exits hiccup mode current limit quickly	C
DEMB	33	VOUT1 and VOUT2 = regulation and there is erratic switching.	C
MODE	34	VOUT1 = regulation, VOUT2 = 0 V, and error amplifier CH2 is set to zero.	B
AGND	35	VOUT1 and VOUT2 = 0 V	B
VDDA	36	VOUT1 and VOUT2 = 0 V, noisy bias rail	B
RT	37	VOUT1 and VOUT2 = 0 V	B
DITH	38	VOUT1 and VOUT2 = regulation, no spread spectrum	C
SYNCOUT	39	VOUT1 and VOUT2 = 0 V, cannot be synchronized to another part	C
EN2	40	VOUT1 and VOUT2 = 0 V	B

Table 4-4. Pin FMA for Device Pins Short-Circuited to Adjacent Pin

Pin Name	Pin No.	Shorted to	Description of Potential Failure Effect(s)	Failure Effect Class
SS1	1	COMP2	VOUT1 = regulation, VOUT2 = VIN	B
COMP2	2	FB2	If FB2 = VDDA, then VOUT1 = regulation and VOUT2 = VIN.	A
			If FB2 = GND, VOUT1 regulation and VOUT2 = 0 V.	B
FB2	3	CS2	If FB2 = VDDA, then VOUT1 = regulation and VOUT2 = 3.3 V.	B
			If FB2 = GND, VOUT1 = regulation and VOUT = 0 V.	B
CS2	4	VOUT2	VOUT1 = regulation, VOUT2 = oscillation	B

Table 4-4. Pin FMA for Device Pins Short-Circuited to Adjacent Pin (continued)

Pin Name	Pin No.	Shorted to	Description of Potential Failure Effect(s)	Failure Effect Class
VOUT2	5	VCCX	If VOUT2 < 6.5 V, VOUT1 and VOUT2 = regulation.	B
			If VOUT2 > 6.5 V, the device damage exceeds the absolute maximum rating.	A
VCCX	6	PG2	VOUT1 and VOUT2 = regulation, PG2 corrupted	B
PG2	7	HOL2	VOUT2 and VOUT2 = regulation, PG2 corrupted	B
			If HOL2 > 6.5 V, the pin exceeds the maximum rating and the PG2 pin is damaged.	A
HOL2	8	HO2	VOUT1 and VOUT2 = regulation	D
HO2	9	SW2	VOUT1 = regulation, VOUT2 < 3 V	B
SW2	10	HB2	VOUT1 = regulation, VOUT2 = 0 V	B
HB2	11	LOL2	VOUT1 and VOUT2 = 0 V	B
LOL2	12	LO2	VOUT1 and VOUT2 = regulation	B
LO2	13	PGND2	VOUT1 and VOUT2 = regulation	B
PGND2	14	VCC	VOUT1 and VOUT2 = 0 V	A
VCC	15	VCC	VOUT1 and VOUT2 = regulation	D
VCC	16	PGND1	VOUT1 and VOUT2 = 0 V	A
PGND1	17	LO1	VOUT1 and VOUT2 = regulation	C
LO1	18	LOL1	VOUT1 and VOUT2 = regulation	D
LOL1	19	HB1	VOUT1 = 0 V, VOUT2 = regulation	B
HB1	20	SW1	VOUT1 = 0 V, VOUT2 = regulation	B
SW1	21	HO1	VOUT1 = 0 V, VOUT2 = regulation	B
HO1	22	HOL1	VOUT1 and VOUT2 = regulation	D
HOL1	23	PG1	VOUT1 = regulation, VOUT2 = regulation, PG1 corrupted	D
			If HOL1 > 6.5 V, the pin exceeds the maximum ratings PG1 and the device is possibly damaged.	A
PG1	24	VIN	If V _{IN} < 6.5 V, VOUT1 and VOUT2 = regulation. If V _{IN} > 6.5 V, the pin exceeds the maximum rating of PG1 and the device is damaged.	A
			If V _{IN} > 6.5 V, the pin exceeds the maximum rating of PG1 and the device is damaged.	A
VIN	25	VOUT1	VOUT1 = VIN, there is no switching, and VOUT2 = regulation	B
VOUT1	26	CS1	VOUT1 = oscillation, VOUT2 = regulation	B
CS1	27	FB1	If FB1 = VDDA, then VOUT1 = 3.3 V and VOUT2 = regulation.	B
			If FB1 = GND, VOUT1 = 0 V and VOUT2 = regulation.	B
FB1	28	COMP1	If FB1 = VDDA, then VOUT1 = VIN, there is excessive current from VIN, and VOUT2 = regulation.	A
			If FB1 = GND, then VOUT1 = 0 V and VOUT2 = regulation.	B
COMP1	29	SS1	VOUT1 = VIN, VOUT2 = regulation	B
SS1	30	EN1	If EN < 6.5 V, VOUT1 and VOUT2 = regulation.	D
			If EN1 > 6.5 V, this pin exceeds the maximum ratings of SS1 pin and the device is damaged.	A
EN1	31	RES	If EN < 6.5 V, VOUT1 and VOUT2 = regulation.	D
			If EN1 > 6.5 V, this pin exceeds the maximum ratings of RES pin and the device is damaged.	A
RES	32	DEMB	VOUT1 and VOUT2 = regulation	B
DEMB	33	MODE	If DEMB = MODE = GND, then the pin is configured as independent dual-output. VOUT1 and VOUT2 = regulation	B
			If DEMB = MODE = VDDA, then the pin is configured as single-output interleaved. VOUT1 and VOUT2 = 0 V	B
MODE	34	AGND	If MODE = GND, VOUT1 and VOUT2 = regulation and the pin is always in independent dual-output operation.	D
AGND	35	VDDA	VOUT1 and VOUT2 = 0 V	B
VDDA	36	RT	VOUT1 and VOUT2 = 0 V, no switching	B
RT	37	DITH	VOUT1 = VOUT2 = oscillation	B
DITH	38	SYNCOUT	VOUT1 = regulation, VOUT2 = regulation, and no spread spectrum	C
SYNCOUT	39	EN2	VOUT1 = regulation, VOUT2 = 0 V	B
EN2	40	SS2	If EN < 6.5 V, then VOUT1 and VOUT2 = regulation.	D
			If EN1 > 6.5 V, this pin exceeds the maximum ratings of SS1 pin and the device is damaged.	A

Table 4-5. Pin FMA for Device Pins Short-Circuited to VIN

Pin Name	Pin No.	Description of Potential Failure Effect(s)	Failure Effect Class
SS1	1	If $V_{IN} < 6.5$ V, then V_{OUT1} and $V_{OUT2} =$ regulation.	D
		If $V_{IN} > 6.5$ V, then the pin exceeds the SS1 maximum rating and the SS1 pin is damaged.	A
COMP2	2	If $V_{IN} > 5$ V and < 6.5 V, then V_{OUT1} and $V_{OUT2} = 0$ V.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the COMP2 maximum rating and the COMP2 pin is damaged.	A
FB2	3	If $V_{IN} < 6.5$ V and $FB2 = V_{DDA}$, then $V_{OUT1} =$ regulation and $V_{OUT2} = 3.3$ V.	B
		If $V_{IN} < 6.5$ V and $FB2 = GND$, then V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the FB2 pin voltage and the FB2 pin is damaged.	A
CS2	4	If $V_{IN} < 60$ V, $V_{OUT1} =$ regulation and $V_{OUT2} = V_{IN}$.	B
		If $V_{IN} > 60$ V, the pin exceeds the maximum ratings of the CS2 pin and the CS2 pin is damaged.	A
VOUT2	5	If $V_{IN} < 60$ V, $V_{OUT1} =$ regulation and $V_{OUT2} = V_{IN}$.	B
		If $V_{IN} > 60$ V, the pin exceeds the maximum ratings of the VOUT2 pin and the VOUT2 pin is damaged.	A
VCCX	6	If $V_{IN} < 6.5$ V and $VCCX = V_{OUT2}$, $V_{OUT1} =$ regulation and $V_{OUT2} = V_{IN}$.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the VCCX pin and the VCCX pin is damaged.	A
PG2	7	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation and PG2 is forced high.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the PG2 pin and the PG2 pin is damaged.	A
HOL2	8	If $V_{IN} < 6.5$ V, $V_{OUT1} =$ regulation, $V_{OUT2} = V_{IN} -$ dropout, and there is no switching.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HOL2 pin and the HOL2 pin is damaged.	A
HO2	9	If $V_{IN} < 6.5$ V, $V_{OUT1} =$ regulation, $V_{OUT2} = V_{IN} -$ dropout, and there is no switching.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HO2 pin and the HO2 pin is damaged.	A
SW2	10	$V_{OUT1} =$ regulation, $V_{OUT2} = V_{IN}$, and there is excessive current from VIN.	B
HB2	11	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation and there is erratic switching on CH2.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HB2 pin and the HB2 pin is damaged.	A
LOL2	12	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the LOL2 pin and the LOL2 pin is damaged.	A
LO2	13	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the LO2 pin and the LO2 pin is damaged.	A
PGND2	14	V_{OUT} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
VCC	15	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the VCC pin and the VCC pin is damaged.	A
VCC	16	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the VCC pin and the VCC pin is damaged.	A
PGND1	17	V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
LO1	18	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the LO1 pin and the LO1 pin is damaged.	A
LOL1	19	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} = 0$ V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the LOL1 pin and the LOL1 pin is damaged.	A
HB1	20	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation.	C
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HB1 pin and the HB1 pin is damaged.	A
SW1	21	$V_{OUT1} = V_{IN}$, $V_{OUT2} =$ regulation, and excessive current from VIN	B
HO1	22	If $V_{IN} < 6.5$ V, $V_{OUT1} = V_{IN} -$ dropout, $V_{OUT2} =$ regulation, and there is no switching.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HB1 pin and HO1 pin is damaged.	A
HOL1	23	If $V_{IN} < 6.5$ V, $V_{OUT1} = V_{IN} -$ dropout, $V_{OUT2} =$ regulation, and there is no switching.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the HB1 pin and the HOL1 pin is damaged.	A
PG1	24	If $V_{IN} < 6.5$ V, V_{OUT1} and $V_{OUT2} =$ regulation and PG1 is forced high.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the PG1 pin and the PG1 pin is damaged.	A
VIN	25	V_{OUT1} and $V_{OUT2} =$ regulation	D
VOUT1	26	If $V_{IN} < 60$ V, then $V_{OUT1} = V_{IN}$ and $V_{OUT2} =$ regulation.	B
		If $V_{IN} > 60$ V, the pin exceeds the maximum ratings of the VOUT1 pin and the VOUT1 pin is damaged.	A
CS1	27	If $V_{IN} < 60$ V, then $V_{OUT1} = V_{IN}$ and $V_{OUT2} =$ regulation.	B
		If $V_{IN} > 60$ V, the pin exceeds the maximum ratings of the CS1 pin, CS1 pin damage	A

Table 4-5. Pin FMA for Device Pins Short-Circuited to VIN (continued)

Pin Name	Pin No.	Description of Potential Failure Effect(s)	Failure Effect Class
FB1	28	If $V_{IN} < 6.5$ V and FB1 = VDDA, then VOUT1 = 3.3 V and VOUT2 = regulation.	B
		If $V_{IN} < 6.5$ V and FB1 = GND, then VOUT1 and VOUT2 = 0 V and there is excessive current from VIN.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the maximum ratings of the FB1 pin voltage and the FB1 pin is damaged.	A
COMP1	29	If $V_{IN} > 5$ V and < 6.5 V, VOUT1 and VOUT2 = 0 V.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the COMP1 maximum rating and the COMP1 pin is damaged.	A
SS1	30	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the SS1 maximum rating and the SS1 pin is damaged.	A
EN1	31	VOUT1 and VOUT2 regulation	D
RES	32	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation and no hiccup mode.	C
		If $V_{IN} > 6.5$ V, the pin exceeds the RES maximum rating and the RES pin is damaged.	A
DEMB	33	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the DEMB maximum rating and the DEMB pin is damaged.	A
MODE	34	If MODE = GND, VOUT1 and VOUT2 = 0 V.	B
		If MODE = VDDA and $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the MODE pin maximum rating and the MODE pin is damaged.	A
AGND	35	VOUT1 and VOUT2 = 0 V. Excessive current from VIN	B
VDDA	36	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	D
		If $V_{IN} > 6.5$ V, the pin exceeds the VDDA pin maximum rating and the VDDA pin is damaged.	A
RT	37	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = 0 V.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the RT pin maximum rating and the RT pin is damaged.	A
DITH	38	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the DITH pin maximum rating and the DITH pin is damaged.	A
SYNCOUT	39	If $V_{IN} < 6.5$ V, VOUT1 and VOUT2 = regulation.	B
		If $V_{IN} > 6.5$ V, the pin exceeds the SYNCOUT pin maximum rating and the SYNCOUT pin is damaged.	A
EN2	40	VOUT1 and VOUT2 = regulation	D

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